



Superconducting and Quantum Metamaterials, Metacircuits, and Metadevices

Guest Editor:

Dr. Kaveh Delfanazari

Department of Physics, University
of Cambridge, Cambridge, UK

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Message from the Guest Editor

The aim of this Special Issue is to highlight recent developments and advances in the theory, design, modeling, fabrication, characterization/experiment, and application of superconducting and quantum metamaterials, metacircuits, and metadevices operating at DC, RFs, microwaves, millimetre-waves, terahertz, and optics that address multiple aspects of challenges in:

- cavity Josephson plasmonics;
- plasmonic superconducting metadevices and metacircuits;
- superconducting quantum/Josephson metamaterials;
- low-loss superconducting–semiconducting/graphene/insulator hybrid metamaterials;
- superconducting hyperbolic metamaterials; or
- waveguide quantum electrodynamics.

Keywords:

- superconducting plasmonic metamaterials;
- Josephson plasmonics;
- Josephson junctions;
- quantum circuits and electrodynamics;
- quantum metamaterials;
- hybrid superconducting–semiconducting/graphene/insulator metamaterials;
- cavity and waveguide quantum electrodynamics.





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Editor-in-Chief

Prof. Dr. Maryam Tabrizian

1. Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada

2. Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Materials Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

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